

RS3 Series

Fast Recovery Power Diode



Features:

- For surface mounted application
- Glass passivated junction chip
- Built-in strain relief, ideal for automated placement
- Fast switching for high efficiency
- High temperature soldering : 260°C/10 seconds at terminals

Mechanical Data:

Cases : Moulded plastic
 Terminals : Solder plated
 Polarity : Indicated by cathode band

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Type Number	Symbol	RS3B	RS3K	Unit
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	100	800	V
Maximum RMS Voltage	V_{RMS}	70	560	
Maximum DC Blocking Voltage	V_{DC}	100	800	
Maximum Average Forward Rectified Current See Figure 1 at $T_L = 75^\circ\text{C}$	$I_{(AV)}$	3		A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	100		
Maximum Instantaneous Forward Voltage at 3A	V_F	1.3		V
Maximum DC Reverse Current at $T_A = 25^\circ\text{C}$ at Rated DC Blocking Voltage at $T_A = 125^\circ\text{C}$	I_R	10 250		μA
Maximum Reverse Recovery Time (Note 1)	T_{rr}	150	500	nS
Typical Junction Capacitance (Note 2)	C_j	60		pF
Typical Thermal Resistance (Note 3)	$R_{\theta JA}$ $R_{\theta JL}$	50 15		$^\circ\text{C/W}$
Operating Temperature Range	T_j	-55 to +150		$^\circ\text{C}$
Storage Temperature Range	T_{STG}			

Notes:

1. Reverse Recovery Test Conditions : $I_F = 0.5\text{A}$, $I_R = 1\text{A}$, $I_{RR} = 0.25\text{A}$
2. Measured at 1MHz and Applied $V_R = 4\text{V}$
3. Thermal Resistance from Junction to Ambient and from Junction to Lead Mounted on PCB with 0.6" x 0.6" (16mm x 16 mm) Copper Pad Areas.



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Ratings and Characteristic Curves

Figure 1 Max. Forward Current Derating Curve

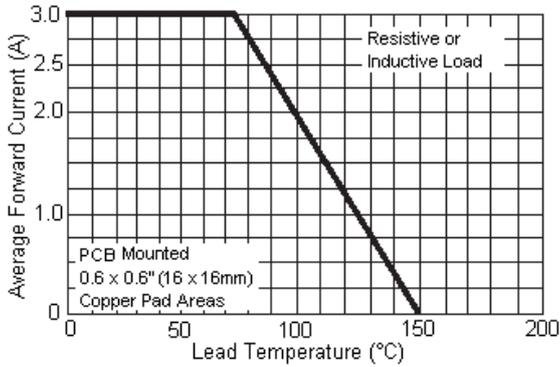


Figure 2 Max. Non-Repetitive Forward Surge Current

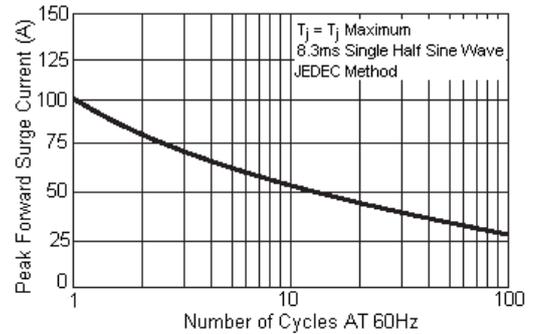


Figure 3 Typical Instantaneous Forward Characteristics

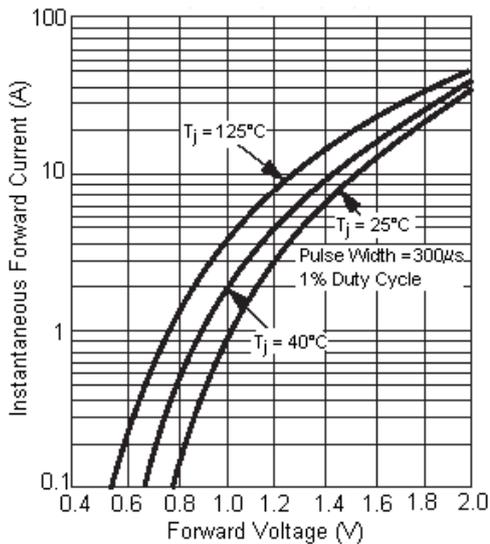


Figure 4 Typical Reverse Characteristics

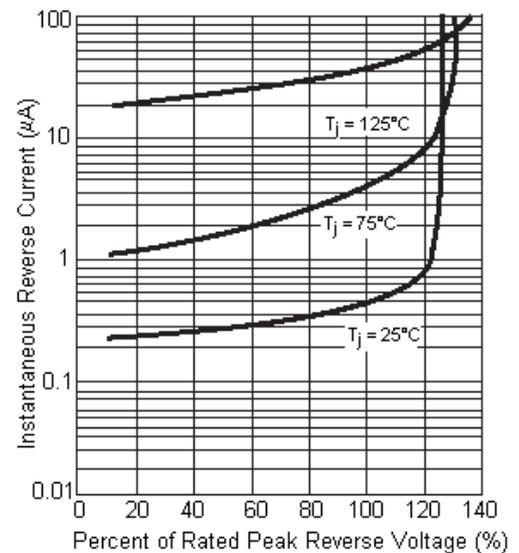
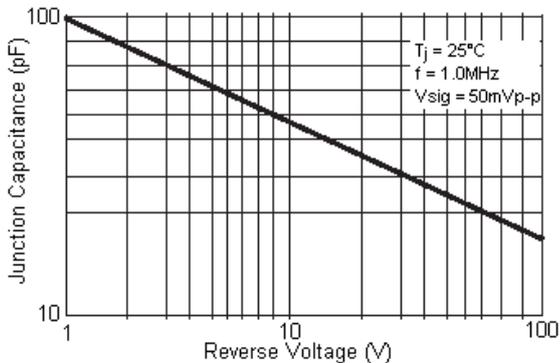


Figure 5 Typical Junction Capacitance



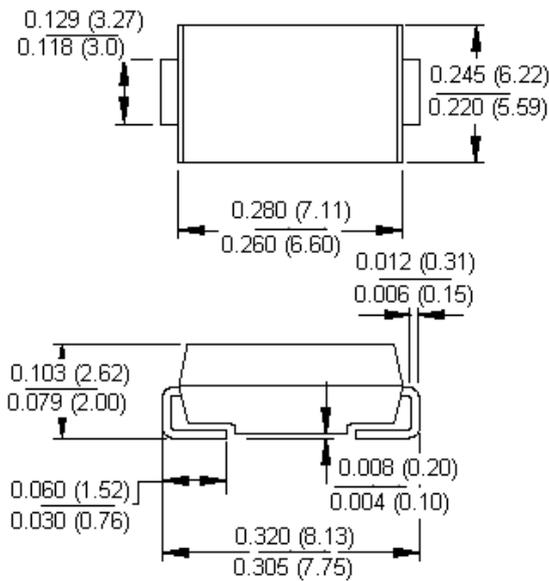
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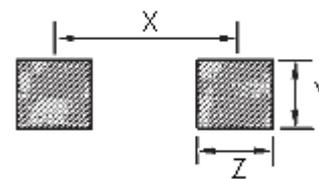


Dimensions:

SMC/DO-214AB



Foot Print



Length	Width	Depth	X	Y	Z
8.13	6.22	2.62	6.5	3.2	1.8

Dimensions : Millimetres

Dimensions : Inches (Millimetres)

Part Number Table

$I_{F(av)}$ (A)	V_{RRM} (V)	I_{FSM} (A)	t_{RR} Max (nS)	V_F (V) at $I_F = 3(A)$	Package	Part Number
3	100	100	150	1.3	DO-214AB (SMC)	RS3B
	800		500			RS3K

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